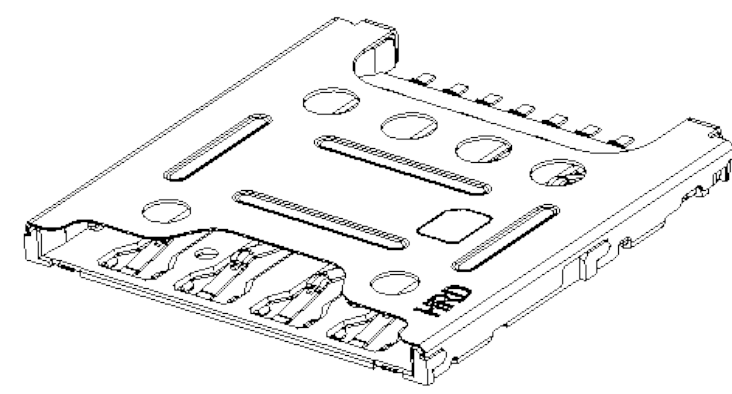


VACCUM AREA(2.00MM)

- NOTES:
- MATERIAL:
HOUSING: LCP, BLACK, UL 94V-0
CONTACT: PHOSPHORBRONZE, T=0.08MM
SHELL: STAINLESS STEEL T=0.10MM
 - FINISH:
CONTACT: NI 50u" MIN PLATING OVER ALL GOLD FLASH ON THE CONTACT AREA AND SOLDER AREA
SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA 50u" NI MIN. PLATING OVER ALL
 - ALL DIMENSIONS MARKED ∇ MUST BE CONTROLLED EVERYDAY BY QC
MARKED ∇ PER WORK WEEK AND ∇ PER MONTH MUST BE CONTROLLED.
 - RATED PARAMETERS OF CONNECTOR
4-1. Operating temperature: -40°C to 85°C
4-2. Rated Current: 0.5A
4-3. Rated Voltage: 30V DC Per Contact
 - ELECTRICAL MECHANICAL ENVIRONMENTAL
5-1. Dielectric withstanding Voltage : 500V AC 1min.
5-2. Insulation Resistance: 1000 MΩ Min.
5-3. Normal Force: 100g Min. Per Pin
5-4. Durability: 1000 cycles
5-5. Contact Resistance: 100mΩ MAX.



				UNITS: mm	GENERAL TOLERANCE		DRAW:	PART NO: S129-0B09F12F
				DATE: 04/10/2017	X. ±0.25 .X ±0.15 .XX ±0.10 .XXX ±0.05	X.° ±5.00° .X.° ±3.00° .XX.° ±1.00°	CHECKED:	TITLE: MICRO SIM CARD 成品H=1.18mm
B	E1704088A	NEW	04/10/2017	SCALE: 6/1			APPROVE:	DRAWING NO:
A	-----	NEW	04/18/2016	SHEET: 1/1	MATERIAL:		昆山捷皇电子精密科技有限公司 HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.	
REV.	ECN NO.	DESCRIPTION	DATE	REV. B	FINISH: SEE NOTE	∇		